

GENERAL DESCRIPTION

The MC3635 is an ultra-low power, lownoise, integrated digital output 3-axis accelerometer with a feature set optimized for wearables and consumer product motion sensing. Applications include wearable consumer products, IoT devices, user interface control, gaming motion input, electronic compass tilt compensation for cell phones, game controllers, remote controls and portable media products.

Low noise and low power are inherent in the monolithic fabrication approach, where the MEMS accelerometer is integrated in a single-chip with the electronics integrated circuit.

In the MC3635 the internal sample rate can be set from 14 to 1300 samples / second. Specific tap or sample acquisition conditions can trigger an interrupt to a remote MCU. Alternatively, the device supports the reading of sample and event status via polling.

FEATURES

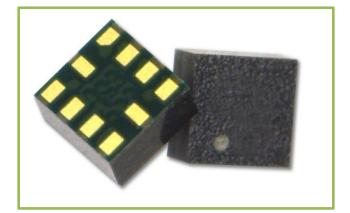
Range, Sampling & Power

- ±2, 4, 8, 12 or 16g ranges
- 8, 10 or 12-bit resolution with FIFO
 14-bit single samples
- Sample rate 14 1300 samples/sec

 Sample trigger via internal oscillator, clock pin or software command
- Sniff and Wake modes
 - o 0.3 µA Sniff current @ 1Hz
 - Separate or combined sniff/wake
- Ultra-Low Power with 32 sample FIFO
 - 0.9 µA typical current @ 25Hz
 - 1.6 μA typical current @ 50Hz
 - 2.8 μA typical current @ 100Hz
 - 36 µA typical current @ 1300Hz

Simple System Integration

- I2C interface, up to 1 MHz
- SPI Interface, up to 8 MHz
- 1.6 × 1.6 × 0.94 mm 10-pin package
- Single-chip 3D silicon MEMS
- Low noise to 2.3mgRMS
- ROHS Compliant



APS-048-0044v1.5



TABLE OF CONTENTS

1	Ord	ler Information	5
2	Fur	nctional Block Diagram	6
3	Pac	ckaging and Pin Description	7
3.1		Package Outline	7
3.2		Package Orientation	8
3.3		Pin Description	9
3.4		Typical Application Circuits	. 10
3.5		Tape and Reel	. 13
3.6		Soldering Profile	. 15
3.7		Shipping and Handling Guidelines	. 15
3.8		Moisture Sensitivity Level Control	. 15
4	Spe	ecifications	. 16
4.1		Absolute Maximum Ratings	. 16
4.2		Sensor Characteristics	. 17
4.3		Electrical and Timing Characteristics	. 18
4.	3.1	Electrical Power and Internal Characteristics	. 18
4.	3.2	Electrical Characteristics	. 19
4.	3.3	I2C Timing Characteristics	. 20
4.	3.4	SPI Timing Characteristics	. 21
5	Ger	neral Operation	. 22
5.1		Sensor Sampling	. 22
5.2		Offset and Gain Calibration	. 22
5.3		Reset	. 22
5.4		Reload	. 23
5.5		Operational Modes	. 24
5.6		Mode State Machine Flow	. 25
6	Inte	erfaces	. 26
6.1		SPI vs I2C Operation Modes	. 26
6.2		I2C Physical Interface	. 26
6.3		I2C Message Format	. 27
6.4		SPI Physical Interface	. 28
6.5		SPI 3-Wire Mode	. 28

6.6	SPI Protocol	
6.7	SPI Register Write Cycle - Single	29
6.8	SPI Register Write Cycle - Burst	29
6.9	SPI Register Read Cycle - Single	29
6.10	0 SPI Register Read Cycle - Burst	30
6.1 ⁻	1 SPI Status Option	30
6.12	2 SPI High-Speed Mode	31
7	Register Interface	32
7.1	Register Summary	33
7.2	(0x00) Extended Status Register 1	35
7.3	(0x01) Extended Status Register 2	
7.4	(0x02 – 0x07) XOUT, YOUT & ZOUT Data Output Registers	
7.5	(0x08) Status Register 1	
7.6	(0x09) Status Register 2	40
7.7	(0x0D) Feature Register 1	42
7.8	(0x0E) Feature Register 2	44
7.9	(0x0F) Initialization Register 1	47
7.10	0 (0x10) Mode Control Register	
7.1 [°]	1 (0x11) Rate Register 1	50
7.12	2 (0x12) Sniff Control Register	52
7.13	3 (0x13) Sniff Threshold Control Register	55
7.14	4 (0x14) Sniff Configuration Register	58
7.1	5 (0x15) Range and Resolution Control Register	60
7.16	6 (0x16) FIFO Control Register	62
7.17	7 (0x17) Interrupt Control Register	63
7.18	8 (0x1A) Initialization Register 3	65
7.19	9 (0x1B) Scratchpad Register	66
7.20	0 (0x1C) Power Mode Control Register	67
7.2	1 (0x20) Drive Motion X Register	69
7.22	2 (0x21) Drive Motion Y Register	70
7.23	3 (0x22) Drive Motion Z Register	71
7.24	4 (0x24) Reset Register	72
7.2	5 (0x28) Initialization Register 2	73
7.26	6 (0x29) Trigger Count Register	74



7.27	7 (0x2A – 0x2B) X-Axis Offset Registers	75
7.28	3 (0x2C – 0x2D) Y-Axis Offset Registers	76
7.29	0 (0x2E – 0x2F) Z-Axis Offset Registers	77
7.30	0 (0x2B & 0x30) X-Axis Gain Registers	78
7.31	l (0x2D & 0x31) Y-Axis Gain Registers	79
7.32	2 (0x2F & 0x32) Z-Axis Gain Registers	80
8	Index of Tables	81
9	Revision History	83
10	Legal	84



1 ORDER INFORMATION

Part Number	Resolution	Order Number	Package	Shipping
MC3635	8 to 14-bit	MC3635	LGA-10	Tape & Reel, 5Ku

Table 1. Order Information

Table 2. Top Marking Specification

C C C	Row	Marking
ССС	CCC	Factory lot code
• X X	XX	Device identifier
		Pin1 identifier



2 FUNCTIONAL BLOCK DIAGRAM

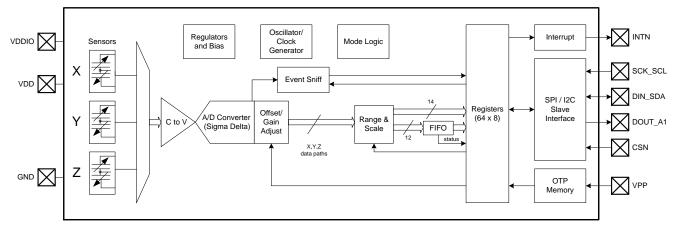


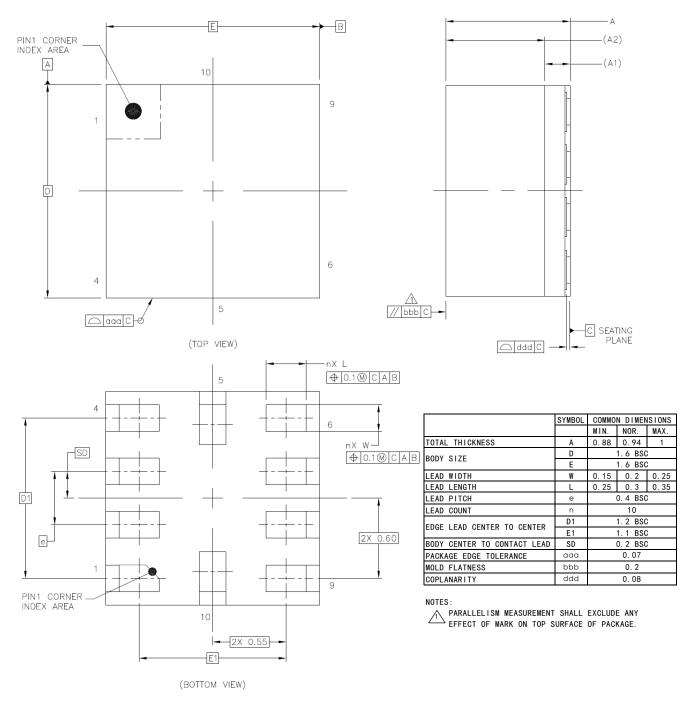
Figure 1. Block Diagram

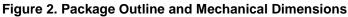
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3 PACKAGING AND PIN DESCRIPTION

3.1 PACKAGE OUTLINE







3.2 PACKAGE ORIENTATION

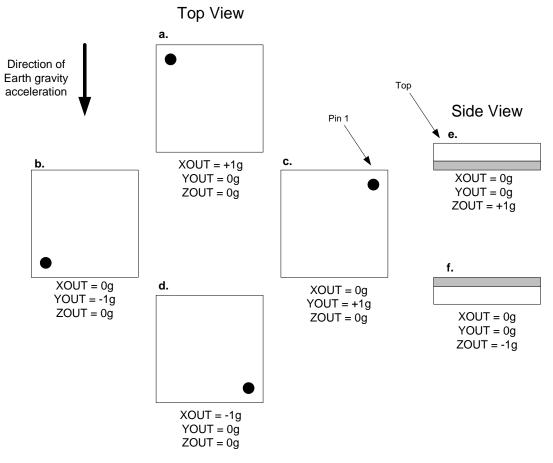


Figure 3. Package Orientation

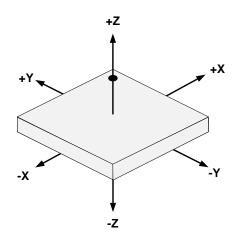


Figure 4. Package Axis Reference

APS-048-0044v1.5



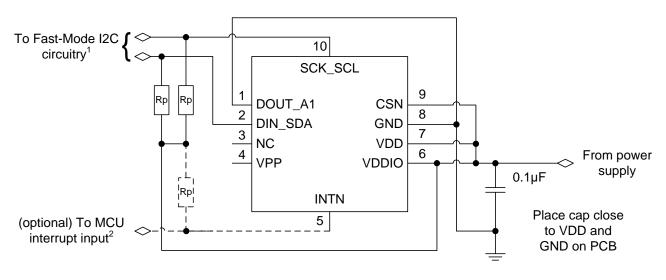
3.3 PIN DESCRIPTION

Pin	Name	Function
1	DOUT_A1	SPI data output I2C address bit 1
2	DIN_SDA ¹	SPI data In I2C serial data input/output
3	NC	No connect
4	VPP	Connect to GND
5	INTN ²	Interrupt active LOW ³
6	VDDIO	Power supply for interface
7	VDD	Power supply for internal
8	GND	Ground
9	CSN	SPI Chip Select
10	SCK_SCL ¹	SPI Clock I2C serial clock input

Table 3. Pin Description

Notes:

- When using the I2C interface, this pin requires a pull-up resistor, typically 4.7kΩ to pin VDDIO. Refer to I2C Specification for Fast-Mode devices. Higher resistance values can be used (typically done to reduce current leakage) but such applications are outside the scope of this datasheet.
- This pin can be configured by software to operate either as an open-drain output or push-pull output. If set to open-drain, then it requires a pull-up resistor, typically 4.7kΩ to pin VDDIO.
- 3) INTN pin polarity is programmable.

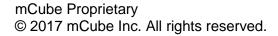


3.4 TYPICAL APPLICATION CIRCUITS

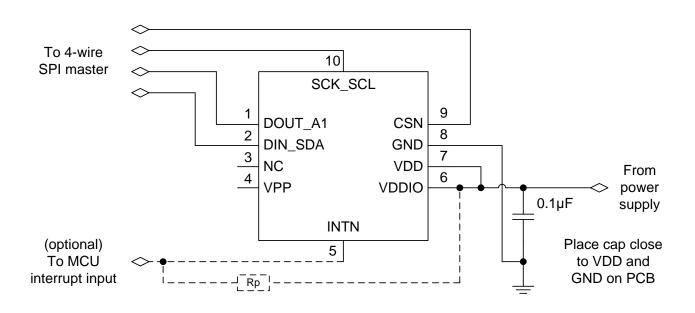
NOTE¹: Rp are typically 4.7kΩ pullup resistors to VDDIO, per I2C specification. When VDDIO is powered down, DIN_SDA and SCK_SCL will be driven low by internal ESD diodes. NOTE²: Attach typical 4.7kΩ pullup resistor if INTN is defined as open-drain.

Figure 5. Typical I2C Application Circuit

In typical applications, the interface power supply may contain significant noise from external sources and other circuits which should be kept away from the device. Therefore, for some applications a lower-noise power supply might be desirable to power the device.



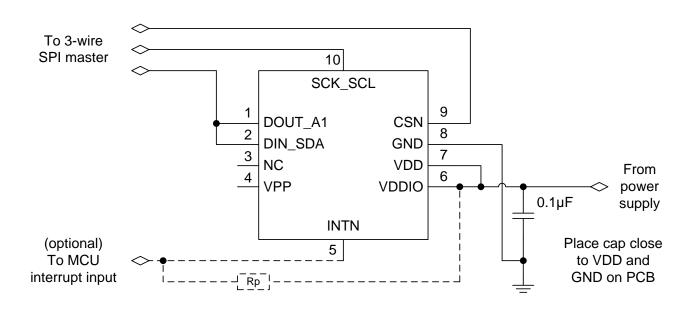




NOTE Rp: Attach typical 4.7k Ω pullup resistor if INTN is defined as open-drain.

Figure 6. Typical 4-wire SPI Application Circuit





NOTE Rp: Attach typical 4.7k Ω pullup resistor if INTN is defined as open-drain.

Figure 7. Typical 3-wire SPI Application Circuit



3.5 TAPE AND REEL

Devices are shipped in reels, in standard cardboard box packaging. See <u>Figure 8. MC3635</u> <u>Tape Dimensions</u> and <u>Figure 9. MC3635 Reel Dimensions</u>.

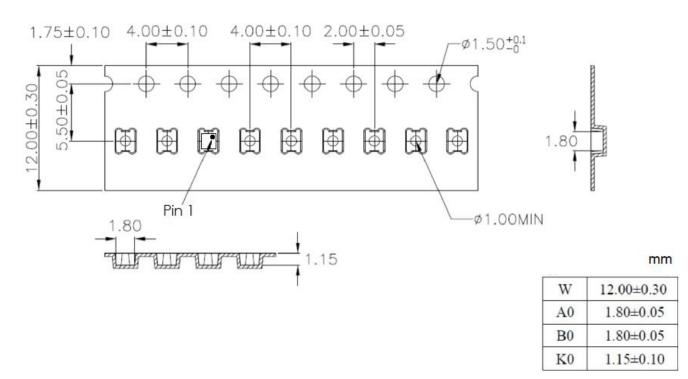
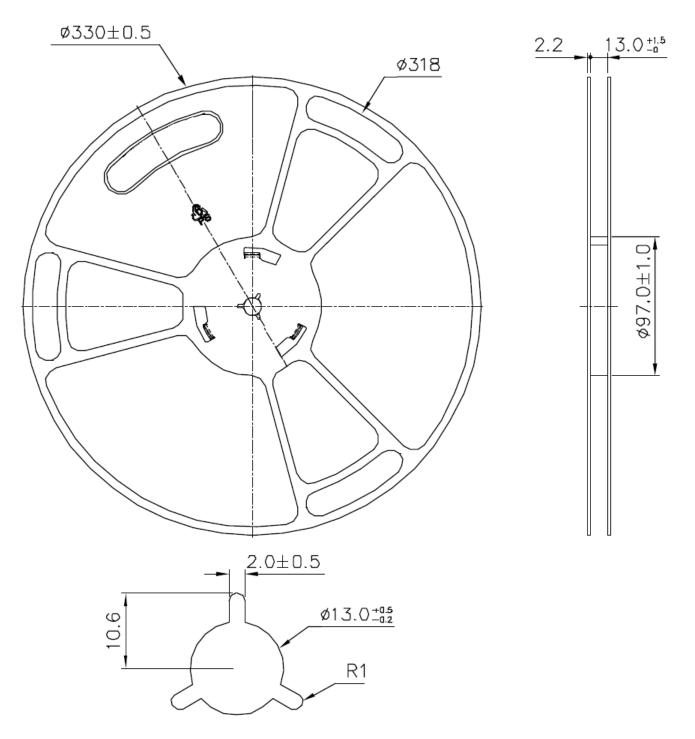


Figure 8. MC3635 Tape Dimensions





• Dimensions in mm.

Figure 9. MC3635 Reel Dimensions

14 / 84

3.6 SOLDERING PROFILE

The LGA package follows the reflow soldering classification profiles described in *Joint Industry Standard, Moisture/Reflow Sensitivity Classification for Nonhermetic Surface Mount Devices,* document number J-STD-020E. Reflow soldering has a peak temperature (T_p) of 260^oC

3.7 SHIPPING AND HANDLING GUIDELINES

Shipping and handling follow the standards described in *Joint Industry Standard, Handling, Packing, Shipping and Use of Moisture/Reflow Sensitive Surface Mount Devices*, document number J-STD-033C.

The following are additional handling guidelines (refer to the mCube document, PCB Design, Device Handling and Assembly Guidelines, document number AN-001, for more information):

- While the mechanical sensor is designed to handle high-g shock events, direct mechanical shock to the package should be avoided.
- SMT assembly houses should use automated assembly equipment with either plastic nozzles or nozzles with compliant tips (for example, soft rubber or silicone).
- Avoid g-forces beyond the specified limits during transportation.
- Handling and mounting of sensors should be done in a defined and qualified installation.

3.8 MOISTURE SENSITIVITY LEVEL CONTROL

The following are storage recommendations (refer to the mCube document, PCB Design, Device Handling and Assembly Guidelines, document number AN-001, for more information):

- Store the tape and reel in the *unopened* dry pack, until required on the assembly floor.
- If the dry pack has been opened or the reel has been removed from the dry pack, reseal the reel inside of the dry pack with a black protective belt. Avoid crushing the tape and reel.
- Store the cardboard box in a vertical position.

15 / 84

4 SPECIFICATIONS

4.1 ABSOLUTE MAXIMUM RATINGS

Parameters exceeding the Absolute Maximum Ratings may permanently damage the device.

Rating	Symbol	Minimum / Maximum Value	Unit
Supply Voltages	Pins VDD, VDDIO	-0.3 / +3.6	V
Acceleration, any axis, 100 µs	9 мах	10000	g
Ambient operating temperature	T _{OP}	-40 / +85	⁰ C
Storage temperature	T _{STG}	-40 / +125	⁰ C
ESD human body model	НВМ	± 2000	V
Input voltage to non-power pin	Pins CSN, DIN_SDA, DOUT_A1, INTN, and SCK_SCL	-0.3 / (VDDIO + 0.3) or 3.6 whichever is lower	V

Table 4. Absolute Maximum Ratings

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4.2 SENSOR CHARACTERISTICS

$VDD = VDDIO = 1.8V, T_{op} =$	25 ^o C unless otherwise noted
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Parameter	Conditions	Min	Тур	Max	Unit
			±2		
Acceleration			±4		
range			±8		g
5			±12		
			±16		
Sensitivity		8		4096	LSB/g
Sensitivity					
Temperature Coefficient ¹			0.015		%/ºC
Zero-g Offset	Post-board mount, ODR <= 400Hz		± 40		mg
Zero-g Offset					
Temperature Coefficient ¹			± 1		mg/⁰C
	WAKE MODES:				
	Ultra-Low Power, Avg X&Y&Z:		6.5		
	Low Power, Avg X&Y&Z:		4.4		
Noise ¹ @	Precision, Avg X&Y&Z:		1.7		mg
100Hz	SNIFF MODES:				RMS
	Ultra-Low Power, Avg X&Y&Z:		40		
	Low Power, Avg X&Y&Z:		25		
	Precision, Avg X&Y&Z:		5		
Nonlinearity ¹			1		% FS
Cross-axis Sensitivity ¹	Between any two axes		2		%

 Table 5. Sensor Characteristics



¹ Values are based on device characterization, not tested in production.

4.3 ELECTRICAL AND TIMING CHARACTERISTICS

4.3.1 ELECTRICAL POWER AND INTERNAL CHARACTERISTICS

Parameter	Conditions	Symbol	Min	Тур	Max	Unit
Internal voltage ²	Pin VDD		1.7	1.8	3.6	V
Internal voltage ²	Rise-time < 40mSec	VDD				V
	Pin VDDIO		4 7	1.8	3.6	V
I/O voltage	Rise-time < 40mSec	VDDIO	1.7			V

Test condition: VDD = VDDIO = 1.8V, T_{op} = 25 ^{0}C unless otherwise noted

Parameter	Conditions	Symbol	Min	Тур	Max	Unit
Sleep current		ddslp		0.1		μA
0.11	1Hz			0.3		μA
Sniff current	6Hz	ddsnf		0.4		μA
	Precision, 14Hz	l _{dd14p}		5		
	Ultra-Low Power, 25Hz	l _{dd25ulp}		0.9		
	Ultra-Low Power, 50Hz	l _{dd50ulp}		1.6		
Selected	Low Power, 54Hz	l _{dd54lp}		2.7		
wake supply current (see	Precision, 55Hz	l _{dd55p}		18		μA
also 7.11)	Ultra-Low Power, 100Hz	l _{dd100ulp}		2.8		
	Precision, 100Hz	l _{dd100p}		36		
	Low Power, 210Hz	l _{dd210lp}		11		
	Ultra-Low Power, 1300Hz	dd1300ulp		36		
Pad Leakage	Per I/O pad	I _{pad}		0.01		μA

Table 6. Electrical Characteristics – Voltage and Current



² Min and Max limits are hard limits without additional tolerance.

4.3.2 ELECTRICAL CHARACTERISTICS

Parameter	Symbol	Min	Мах	Unit
LOW level input voltage	VIL	-0.5	0.3*VDDIO	V
HIGH level input voltage	VIH	0.7*VDDIO	-	V
Hysteresis of Schmitt trigger inputs	Vhys	0.05*VDDIO	-	V
Output voltage, pin INTN, Iol ≤ 2 mA	Vol	0	0.4	V
	Voh	0	0.9*VDDIO	V
Output voltage, pin DIN_SDA (open drain), Iol ≤ 1 mA	Vols	-	0.1*VDDIO	V
Input current, pins DIN_SDA and SCK_SCL (input voltage between 0.1*VDDIO and 0.9*VDDIO max)	li	-10	10	μA
Capacitance, pins DIN_SDA and SCK_SCL 3	Ci	-	10	рF

Table 7. Electrical Characteristics – Interface

NOTES:

- If multiple slaves are connected to the I2C signals in addition to this device, only 1 pullup resistor on each of SDA and SCL should exist. Also, care must be taken to not violate the I2C specification for capacitive loading.
- When pin VDDIO is not powered and set to 0V, INTN, DIN_SDA and SCK_SCL will be held to VDDIO plus the forward voltage of the internal static protection diodes, typically about 0.6V.
- When pin VDDIO is disconnected from power or ground (e.g. Hi-Z), the device may become inadvertently powered up through the ESD diodes present on other powered signals.



³ Values are based on device characterization, not tested in production.

4.3.3 I2C TIMING CHARACTERISTICS

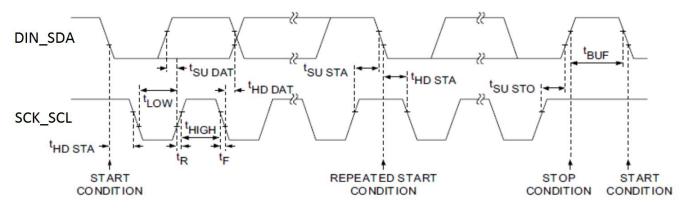


Figure 10. I2C Interface Timing

		Standard Mode		Fast Mode		Fast Mode Plus		Units
Parameter	Description	Min	Max	Min	Max			
f _{SCL}	SCL clock frequency	0	100	0	400	0	1000	kHz
t _{HD; STA}	Hold time (repeated) START condition	4.0	-	0.6	-	0.26	-	μs
t _{LOW}	LOW period of the SCL clock	4.7	-	1.3	-	0.5	-	μs
t _{HIGH}	HIGH period of the SCL clock	4.0	-	0.6	-	0.26	-	μs
t _{SU;STA}	Set-up time for a repeated START condition	4.7	-	0.6	-	0.26	-	μs
t _{HD;DAT}	Data hold time	5.0	-	-	-	-	-	μs
t _{SU;DAT}	Data set-up time	250	-	100	-	50	-	ns
t _{su;sто}	Set-up time for STOP condition	4.0	-	0.6	-	0.26	-	μs
t _{BUF}	Bus free time between a STOP and START	4.7	-	1.3	-	0.5	-	μs

Table 8. I2C Timing Characteristics

NOTE: Values are based on I2C Specification requirements, not tested in production.



4.3.4 SPI TIMING CHARACTERISTICS

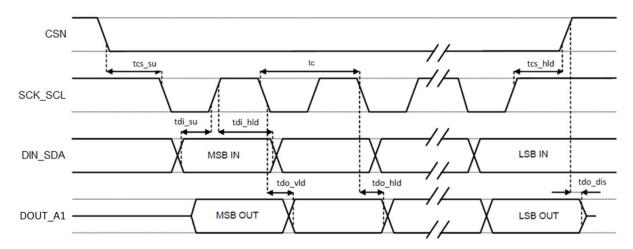


Figure 11. SPI Interface Timing Waveform

Symbol	Parameter		Units		
		Min	Тур	Max	
tc	SPI SCK_SCL Clock Cycle	500			ns
fc	SPI SCK_SCL Clock Frequency		8 ⁴		MHz
tcs_su	SPI CSN Setup Time	6			ns
tcs_hld	SPI CSN Hold Time	8			ns
tdi_su	SPI DIN_SDA Input Setup Time	5			ns
tdi_hld	SPI DIN_SDA Input Hold Time	15			ns
tdo_vld	SPI DOUT_A1 Valid Output Time			50	ns
tdo_hld	SPI DOUT_A1 Output Hold Time	9			ns
tdo_dis	SPI DOUT_A1 Output Disable Time			50	ns

Table 9. SPI Interface Timing Parameters



⁴ Values are based on device characterization.

5 GENERAL OPERATION

The device supports the reading of samples and device status upon interrupt or via polling. It contains a 12-bit 32 sample FIFO with programmable watermark. The device is internally clocked but also includes a manual trigger mode. It can be put into several low power modes, depending upon the desired sensing application. The device can run in full-featured mode from its fast internal clock or from a slower heartbeat clock, with limited functionality and at lower power. The device can connect as a slave to either a SPI or I2C master.

5.1 SENSOR SAMPLING

X, Y and Z accelerometer data is stored in registers XOUT, YOUT, and ZOUT registers. The data is represented as 2's complement format.

The desired resolution and full scale acceleration range are set in the RANGE_C register.

5.2 OFFSET AND GAIN CALIBRATION

The default digital offset and gain calibration data can be read from the device, if necessary, in order to reduce the effects of post-assembly influences and stresses which may cause the sensor readings to be offset from their factory values.

5.3 RESET

The device can be completely reset via an I2C or SPI instruction. Writing register 0x24 with 0x40 (bit 6) causes a power-on reset operation to execute. No attempt should be made to access registers within 1mSec after issuing this operation. The device must be placed in STANDBY mode before executing the reset. The pin DOUT_A1 is sampled for the purposes of setting the I2C device address after this reset operation.

NOTE: Immediately after a RESET or power-up event, several registers must be written with initialization values as shown below. The recommended sequence is:

Step	Address	Value which must be written	Comment
1	0x10	0x01	Go to standby
2	0x24	0x40	Reset (or Power-On)
3	V	/ait at least 1mSec	Wait for reset to complete
4	0x0D	For SPI: 0x80	Specify interface
4	UXUD	For I2C: 0x40	Specify interface
5	0x0F	0x42	Initialization
6	0x20	0x01	Initialization
7	0x21	0x80	Initialization
8	0x28	0x00	Initialization
9	0x1A	0x00	Initialization
10	Со	nfigure remaining registers and us	e sensor as normal

Table 10. Recommended Initialization Sequence



5.4 RELOAD

The device registers can be reloaded from OTP via an I2C or SPI instruction. Writing register 0x24 with 0x80 (bit 7) causes a reload operation to execute. The contents of OTP are reloaded into the register set. However any non-loaded register locations will not be affected. No attempt should be made to access registers within 1mSec after issuing this operation. The device must be placed in STANDBY mode before executing the reset.

The pin DOUT_A1 is sampled for the purposes of setting the I2C device address after this reload operation.



5.5 OPERATIONAL MODES

The device has various modes of operation as described below:

Mode	Description and Comments
SLEEP	SLEEP is the lowest power mode. The internal regulators are enabled, and much of the chip is disabled. The SLEEP mode is the default POR mode. This command is available at any time, although up to three periods of the internal heartbeat clock may be required to complete the transition.
STANDBY	STANDBY is a low power mode. All internal regulators are enabled, and internal main and heartbeat clocks are enabled. The default STANDBY frequency for the heartbeat clock is ~500 Hz. TRIG mode operation can be executed only from this mode. Software must change the mode to SLEEP or STANDBY in register 0x10 before writing to any other register.
SNIFF	SNIFF is a lower power, limited activity detection mode; Sniff circuitry is enabled and sniff-only sampling is enabled. There are no FIFO operations, and hardware will automatically transition to CWAKE mode upon activity detection.
CWAKE	CWAKE or continuous wake is the typical XYZ sampling mode. Sample data is written to the output registers, or the FIFO when enabled. Hardware will automatically transition to CWAKE mode upon SNIFF activity detection.
SWAKE	SNIFF and CWAKE circuitry are both active simultaneously. Sniff circuitry is enabled and XYZ samples are written to the output registers, or the FIFO when enabled.
TRIG	The device produces a fixed number of samples, between 1 and 254, or continuously. This mode ignores the setting in the ODR, but uses the STB_RATE[2:0] clock setting as the sampling rate. The trigger can be set to come from the external pin INTN or a write to register bit 0x10[7].

Table 11. Operational Modes



5.6 MODE STATE MACHINE FLOW

Figure 12. Mode Operational Flow shows the operational mode flow for the device. The device defaults to SLEEP mode following power-on. Mode transitions occur at an approximate rate of ~500Hz. Depending on the operation, the MODE State Machine may trigger events that autoclear or set the MCTRL[2:0] bits in register 0x10 after a particular command is chosen.

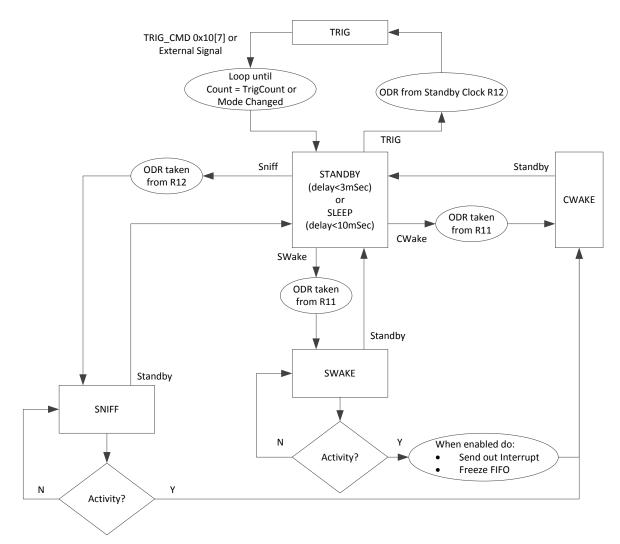


Figure 12. Mode Operational Flow



6 INTERFACES

6.1 SPI VS I2C OPERATION MODES

The device contains both I2C and SPI slave interfaces which share common pins. However, only one interface can be active for correct device operation. Once the device completes POR or a hard reset, both interfaces are active.

After power-up and any reset of the device, the first transaction to the device must be writing to the selected enable bit, either "I2C_EN" or "SPI_EN" in register 0x0D. The situation where bits are set at the same time must be avoided or unstable device operation could occur.

To keep the "disabled" interface from interfering in future transactions, the corresponding "enable" bit must be set in the register set. For example, if the 4-wire SPI interface is to be active, write a value of 0x80 to register 0x0D.

6.2 I2C PHYSICAL INTERFACE

The I2C slave interface operates at a maximum speed of 1 MHz in I2C "Fast Mode Plus". The SDA (data) is an open-drain, bi-directional pin and the SCL (clock) is an input pin.

The device always operates as an I2C slave.

An I2C master initiates all communication and data transfers and generates the SCK_SCL clock that synchronizes the data transfer. The I2C device address depends upon the settings of various registers and pins as shown in the table below.

An I2C master initiates all communication and data transfers and generates the SCK_SCL clock that synchronizes the data transfer. The I2C device address depends upon the state of pin DOUT_A1 during power-up as shown in the table below.

7-bit Device ID	<u>8-bit Address</u> <u>(Write)</u>	<u>8-bit Address</u> <u>(Read)</u>	DOUT_A1 level upon power-up
0x4C (0b1001100)	0x98	0x99	GND
0x6C (0b1101100)	0xD8	0xD9	VDD

Table 12. I2C Address Selection

The I2C interface remains active as long as power is applied to the VDDIO pin. In STANDBY mode the device responds to I2C read and write cycles, but interrupts cannot be cleared. All registers can be written in the SLEEP or STANDBY modes, but in CWAKE only the (0x10) <u>Mode Control Register</u> can be modified.



Internally, the registers which are used to store samples are clocked by the sample clock and gated by I2C activity. Therefore, in order to allow the device to collect and present samples in the sample registers at least one I2C STOP condition must be present between samples.

Refer to the I2C specification for a detailed discussion of the protocol. Per I2C requirements, when the I2C interface is enabled, DIN_SDA is an open drain, bi-directional pin. Pins SCK_SCL and DIN_SDA each require an external pull-up resistor, typically $4.7k\Omega$.

6.3 I2C MESSAGE FORMAT

NOTE: At least one I2C STOP condition must be present between samples in order for the device to update the sample data registers.

The device uses the following general format for writing to the internal registers. The I2C master generates a START condition, and then supplies the 7-bit device ID. The 8th bit is the R/W# flag (write cycle = 0). The device pulls DIN_SDA low during the 9th clock cycle indicating a positive ACK.

The second byte is the 8-bit register address of the device to access, and the last byte is the data to write.

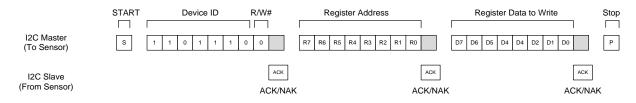


Figure 13. I2C Message Format, Write Cycle, Single Register Write

In a read cycle, the I2C master writes the device ID (R/W#=0) and register address to be read. The master issues a RESTART condition and then writes the device ID with the R/W# flag set to '1'. The device shifts out the contents of the register address.

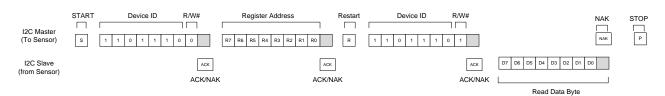


Figure 14. I2C Message Format, Read Cycle, Single Register Read

The I2C master may write or read consecutive register addresses by writing or reading additional bytes after the first access. The device will internally increment the register address.

NOTE: See (0x0E) Feature Register 2 for address wrap details.



6.4 SPI PHYSICAL INTERFACE

The device always operates as an SPI slave. An SPI master must initiate all communication and data transfers and generate the SCK_SCL clock that synchronizes the data transfer. The CSN pin must be pulled up to VDDIO when the SPI interface is not in use. The SPI interface can operate in 3-wire or 4-wire mode.

6.5 SPI 3-WIRE MODE

SPI 3-wire mode is disabled by default. To enable 3-wire mode, the first write to the device should immediately enable this feature in register (0x0D) Feature Register 1. In 3-wire mode the pins DOUT_A1 and DIN_SDA must be connected on the PCB. Anytime there is a reset to the device, a POR event, or a power cycle the SPI 3-wire configuration will reset to 4-wire mode.

6.6 SPI PROTOCOL

The general protocol for the SPI interface is shown in the figures below. The falling edge of CSN initiates the start of the SPI bus cycle. The first byte of the transaction is the command/address byte. Because the register address space is 64 locations, a total of 6 address bits are required for each SPI bus cycle. During clock '1', the R/W# bit is set to '0' for a write cycle or '1' for a read cycle.

The interface supports 2 types of addressing: 1-byte (typically used) and 2-byte (to support legacy hardware). In the case of 2-byte addressing, the bits occurring during clocks 2 and 9-16 must be driven to '0' for the address to be correctly decoded. Each read or write transaction always requires a minimum of 16 or 24 cycles of the SCK_SCL pin.

When the SPI master is writing data, data may change when the clock is low, and must be stable on the clock rising edge. Similarly, output data written to the SPI master is shifted out on the falling edge of clock and can be latched by the master on the rising edge of the clock. Serial data in or out of the device is always MSB first.

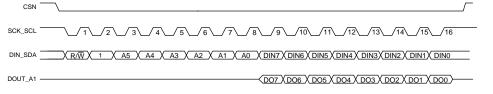


Figure 15. General SPI Protocol, 1-Byte Address

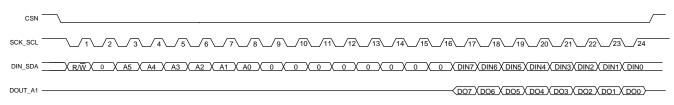


Figure 16. General SPI Protocol, 2-Byte Address (legacy)



NOTE: Either 1-byte or 2-byte addressing may be used for any SPI transaction, although for simplicity, the remaining timing diagrams show only 1-byte addressing.

6.7 SPI REGISTER WRITE CYCLE - SINGLE

A single register write consists of a 16-clock transaction. As described above, the first bit is set to '0' indicating a register write followed by the register address.

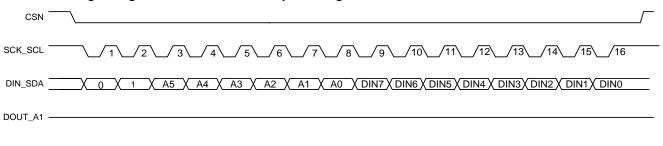


Figure 17. SPI Register Write Cycle - Single

6.8 SPI REGISTER WRITE CYCLE - BURST

A burst (multi-byte) register write cycle uses the address specified at the beginning of the transaction as the starting register address. Internally the address will auto-increment to the next consecutive address for each additional byte (8-clocks) of data written beyond clock 8.

NOTE: See (0x0E) Feature Register 2 for address wrap details.

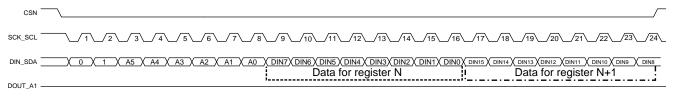


Figure 18.SPI Register Write Cycle - Burst (2-register burst example)

6.9 SPI REGISTER READ CYCLE - SINGLE

A single register read consists of a 16-clock transaction. As described above, the first bit is set to '1' indicating a register read followed by the register address.

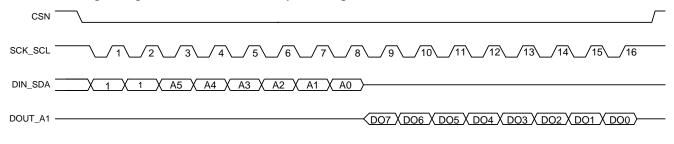


Figure 19. SPI Register Read Cycle - Single

29 / 84

6.10 SPI REGISTER READ CYCLE - BURST

A burst (multi-byte) register read cycle uses the address specified at the beginning of the transaction as the starting register address. Internally the address will auto-increment to the next consecutive address for each additional byte (8-clocks) of data read beyond clock 8.

NOTE: See (0x0E) Feature Register 2 for address wrap details.

Figure 20. SPI Register Read Cycle - Burst (2 register burst example)

6.11 SPI STATUS OPTION

The device supports an optional SPI status feature, only in SPI 4-wire mode. This feature is enabled in register (0x0E) Feature Register 2. During the first 6-bits of any SPI transaction (immediately after the falling edge of CSN), the DOUT_A1 pin will output six status bits related to the device. Following the 6th clock cycle, the device will float the DOUT_A1 pin before a possible read cycle begins. The status bits sent are shown below:

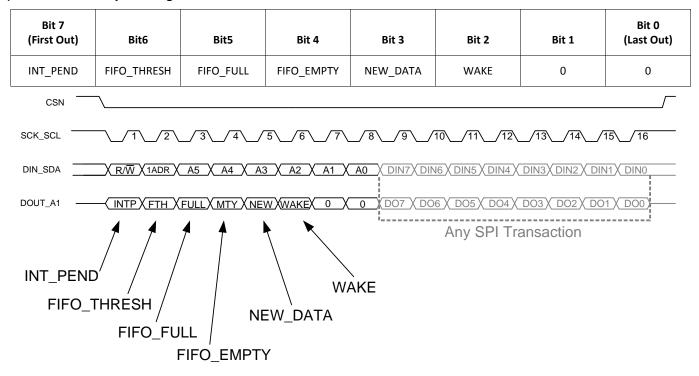


Figure 21. SPI Status bits



6.12 SPI HIGH-SPEED MODE

To achieve SPI speed greater than 2MHz, use the following sequence:

- Start SPI at low speed (less than 2MHz)
- Enable SPI mode -
 - "SPI_EN" in section 7.7 (0x0D) Feature Register 1
- Enable high speed SPI mode -
 - "SPI_HS_EN" in section 7.20 (0x1C) Power Mode Control Register
- Increase SPI speed up to 8MHz



7 REGISTER INTERFACE

The device has a simple register interface which allows an SPI or I2C master to configure and monitor all aspects of the device. This section lists an overview of user programmable registers. By convention, bit 0 is the least significant bit (LSB) of a byte register.



7.1 REGISTER SUMMARY

Addr	Name	Description	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	POR Value	R/W⁴
0x00	EXT_STAT_1	Extended Status 1	RESV	RESV	RESV	RESV	12C_AD0	RESV	RESV	RESV	0x00	R
0x01	EXT_STAT_2	Extended Status 2	SNIFF_ DETECT	SNIFF_EN	OTP_ BUSY	RESV	RESV	RESV	PD_CLK_ STAT	OVR_ DATA	0x04	R
0x02	XOUT_LSB	XOUT_LSB	XOUT[7]	XOUT[6]	XOUT[5]	XOUT[4]	XOUT[3]	XOUT[2]	XOUT[1]	XOUT[0]	0x00	R
0x03	XOUT_MSB	XOUT_MSB	XOUT[15]	XOUT[14]	XOUT[13]	XOUT[12]	XOUT[11]	XOUT[10]	XOUT[9]	XOUT[8]	0x00	R
0x04	YOUT_LSB	YOUT_LSB	YOUT[7]	YOUT[6]	YOUT[5]	YOUT[4]	YOUT[3]	YOUT[2]	YOUT[1]	YOUT[0]	0x00	R
0x05	YOUT_MSB	YOUT_MSB	YOUT[15]	YOUT[14]	YOUT[13]	YOUT[12]	YOUT[11]	YOUT[10]	YOUT[9]	YOUT[8]	0x00	R
0x06	ZOUT_LSB	ZOUT_LSB	ZOUT[7]	ZOUT[6]	ZOUT[5]	ZOUT[4]	ZOUT[3]	ZOUT[2]	ZOUT[1]	ZOUT[0]	0x00	R
0x07	ZOUT_MSB	ZOUT_MSB	ZOUT[15]	ZOUT[14]	ZOUT[13]	ZOUT[12]	ZOUT[11]	ZOUT[10]	ZOUT[9]	ZOUT[8]	0x00	R
0x08	STATUS_1	Status 1	INT_PEND	FIFO_ THRESH	FIFO_FULL	FIFO_ EMPTY	NEW_ DATA	MODE[2]	MODE[1]	MODE[0]	0x00	R
0x09	STATUS_2	Status 2	INT_ SWAKE	INT_FIFO_ THRESH	INT_FIFO_ FULL	INT_FIFO_ EMPTY	INT_ACQ	INT_WAKE	RESV	RESV	0x00	R
0x	0A – 0x0C					RESER'	V ED					
0x0D	FREG_1	Feature 1	SPI_EN	12C_EN	SPI3_EN	INTSC_EN	FREEZE	0	0	0	0x00	w
0x0E	FREG_2	Feature 2	EXT_ TRIG_EN	EXT_ TRIG_POL	FIFO_ STREAM	I2CINT_ WRCLRE	FIFO_ STAT_EN	SPI_ STAT_EN	FIFO_ BURST	WRAPA	0x00	W
0x0F	INIT_1	Initialization 1	0	1	0	0	0	0	1	0	(See note)	WO
0x10	MODE_C	Mode Control	TRIG_ CMD	Z_AXIS_ PD	Y_AXIS_ PD	X_AXIS_ PD	RESV	MCTRL[2]	MCTRL[1]	MCTRL[0]	0x00	W
0x11	RATE_1	Rate 1	0	0	0	0	RR[3]	RR[2]	RR[1]	RR[0]	0x00	W
0x12	SNIFF_C	Sniff Control	STB_RATE [2]	STB_RATE [1]	STB_RATE [0]	0	SNIFF_SR [3]	SNIFF_SR [2]	SNIFF_SR [1]	SNIFF_SR [0]	0x00	W
0x13	SNIFFTH_C	Sniff Threshold Control	SNIFF_ MODE	SNIFF_ AND_OR	SNIFF_ TH[5]	SNIFF_ TH[4]	SNIFF_ TH[3]	SNIFF_ TH[2]	SNIFF_ TH[1]	SNIFF_ TH[0]	0x00	w
0x14	SNIFFCF_C	Sniff Configuration	SNIFF_ RESET	SNIFF_ MUX[2]	SNIFF_ MUX[1]	SNIFF_ MUX[0]	SNIFF_ CNTEN	SNIFF_ THADR[2]	SNIFF_ THADR[1]	SNIFF_ THADR[0]	0x00	w
0x15	RANGE_C	Range Resolution Control	RESV		RANGE[1]	RANGE[0]	RESV	RES[2]	RES[1]	RES[0]	0x00	w
0x16	FIFO_C	FIFO Control	FIFO_ RESET	FIFO_EN	FIFO_ MODE	FIFO_TH[4]	FIFO_TH[3]	FIFO_TH[2]	FIFO_TH[1]	FIFO_TH[0]	0x00	w
0x17	INTR_C	Interrupt Control	INT_ SWAKE	INT_FIFO_ THRESH	INT_FIFO_ FULL	INT_FIFO_ EMPTY	INT_ACQ	INT_ WAKE	ΙАΗ	IPP	0x00	R
0>	(18 – 0x19			1	1	RESER'	VED					<u> </u>
0x1A	INIT_3	Initialization 3	0	0	0	0	0	0	0	0	0x00	RW
0x1B	SCRATCH	Scratchpad	0	0	0	0	0	0	0	0	0x00	RW



MC3635 3-Axis Accelerometer

Addr	Name	Description	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	POR Value	R/₩⁴
0x1C	PMCR	Pow er Mode Control	SPI_HS_EN	SPM[2]	SPM[1]	SPM[0]	RESV	CSPM[2]	CSPM[1]	CSPM[0]	0x00	W
0>	(1D – 0x1F					RESE	RVED					
0x20	DMX	Drive Motion X	0	0	0	0	DNX	DPX	0	1	0x00	W
0x21	DMY	Drive Motion Y	1	0	0	0	DNY	DPY	0	0	(See table)	W
0x22	DMZ	Drive Motion Z	0	0	0	0	DNZ	DPZ	0	0	0x00	W
	0x23					RESE	RVED					
0x24	RESET	Reset	RELOAD	RESET	RESV	RESV	RESV	RESV	RESV	RESV	0x00	W
0	x25 – 0x27					RESE	RVED					
0x28	INIT_2	Initialization Register 2	0	0	0	0	0	0	0	0	0x00	W
0x29	TRIGC	Trigger Count	TRIGC[7]	TRIGC[6]	TRIGC[5]	TRIGC[4]	TRIGC[3]	TRIGC[2]	TRIGC[1]	TRIGC[0]	0x00	W
0x2A	XOFFL	X-Offset LSB	XOFF[7]	XOFF[6]	XOFF[5]	XOFF[4]	XOFF[3]	XOFF[2]	XOFF[1]	XOFF[0]	Per chip	W
0x2B	XOFFH	X-Offset MSB	XGAIN[8]	XOFF[14]	XOFF[13]	XOFF[12]	XOFF[11]	XOFF[10]	XOFF[9]	XOFF[8]	Per chip	W
0x2C	YOFFL	Y-Offset LSB	YOFF[7]	YOFF[6]	YOFF[5]	YOFF[4]	YOFF[3]	YOFF[2]	YOFF[1]	YOFF[0]	Per chip	W
0x2D	YOFFH	Y-Offset MSB	YGAIN[8]	YOFF[14]	YOFF[13]	YOFF[12]	YOFF[11]	YOFF[10]	YOFF[9]	YOFF[8]	Per chip	W
0x2E	ZOFFL	Z-Offset LSB	ZOFF[7]	ZOFF[6]	ZOFF[5]	ZOFF[4]	ZOFF[3]	ZOFF[2]	ZOFF[1]	ZOFF[0]	Per chip	W
0x2F	ZOFFH	Z-Offset MSB	ZGAIN[8]	ZOFF[14]	ZOFF[13]	ZOFF[12]	ZOFF[11]	ZOFF[10]	ZOFF[9]	ZOFF[8]	Per chip	W
0x30	XGAIN	X Gain	XGAIN[7]	XGAIN[6]	XGAIN[5]	XGAIN[4]	XGAIN[3]	XGAIN[2]	XGAIN[1]	XGAIN[0]	Per chip	W
0x31	YGAIN	Y Gain	YGAIN[7]	YGAIN[6]	YGAIN[5]	YGAIN[4]	YGAIN[3]	YGAIN[2]	YGAIN[1]	YGAIN[0]	Per chip	W
0x32	ZGAIN	Z Gain	ZGAIN[7]	ZGAIN[6]	ZGAIN[5]	ZGAIN[4]	ZGAIN[3]	ZGAIN[2]	ZGAIN[1]	ZGAIN[0]	Per chip	W
0:	x33 – 0x3F					RESE	RVED				•	-

Table 13. Register Summary

⁴ 'R' registers are read-only. 'W' registers are read-write. 'WO' registers are write only.



7.2 (0X00) EXTENDED STATUS REGISTER 1

Bit POR R/W Addr Name Value 7 6 5 4 3 2 1 0 0x00 EXT_STAT_1 RESV RESV RESV RESV I2C_AD0 RESV RESV RESV 00000000 R

This register contains status for the I2C address of the device.

Bit	Name	Description
[2:0]	RESV	Reserved
3	I2C_AD0_BIT	Value of I2C slave address obtained from reading the DOUT_A1 pin at POR. If this bit is '1', the 7-bit base address of the I2C slave changes from 0x4C to 0x6C.
[7:4]	RESV	Reserved

Table 14. Extended Status Register 1 Settings



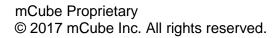
7.3 (0X01) EXTENDED STATUS REGISTER 2

The device status register reports various conditions of the device data, clock and sniff circuitry.

			Bit								
Addr	Name	7	6	5	4	3	2	1	0	POR Value	R/W
0x01	EXT_STAT_2	SNIFF_ DETECT	SNIFF_EN	OTP_BUSY	RESV	RESV	RESV	PD_CLK_ STAT	OVR_ DATA	0x04	RO

Bit	Name	Description
0	OVR_DATA	 0: Previous acceleration sample has not been overwritten before read by host 1: Previous acceleration sample was not read by host and has been overwritten.
1	PD_CLK_STAT	Returns the power-down status of the clocks. 0: Clocks are enabled. 1: Clocks are disabled.
[4:2]	RESV	Reserved
5	OTP_BUSY	OTP VDD status bit: 0: OTP_VDD supply is not enabled, OTP is powered down. 1: OTP_VDD supply is enabled, OTP is powered.
6	SNIFF_EN	SNIFF mode enable flag: 0: SNIFF mode is not active. 1: SNIFF mode is active.
7	SNIFF_DETECT	SNIFF wakeup or detect flag: 0: No sniff event detected. 1: Sniff event detected, move to CWAKE mode.

Table 15. Extended Status Register 2 Settings





7.4 (0X02 – 0X07) XOUT, YOUT & ZOUT DATA OUTPUT REGISTERS

The measurements from sensors for the 3-axes are available in these 3 registers. The mostsignificant bit of the value is the sign bit, and is sign extended to the higher bits.

Software must set only one of the bits SPI_EN or I2C_EN in register 0x0D to '1', depending upon if the I2C or SPI interface will be used for external communications. No data will appear in XOUT, YOUT and ZOUT registers if both the I2C_EN bit and SPI_EN bit are set to 0 (default).

When the FIFO is enabled, the output of the FIFO is mapped to registers 0x02 to 0x07, and the data has a maximum resolution of 12-bits.

During FIFO reads, software must start a read at address 0x02 and complete a read to address 0x07 for the FIFO pointers to increment correctly.

Once an I2C start bit has been recognized by the device, registers will not be updated until an I2C stop bit has occurred. Therefore, if software desires to read the low and high byte registers 'atomically', knowing that the values have not been changed, it should do so by issuing a start bit, reading one register, then reading the other register then issuing a stop bit. Note that all 6 registers may be read in one burst with the same effect.

Addr	Name	Description	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	POR Value	R/ W
0x02	XOUT _LSB	XOUT LSB Register	XOUT [7]	XOUT [6]	XOUT [5]	XOUT [4]	XOUT [3]	XOUT [2]	XOUT [1]	XOUT [0]	0x00	R
0x03	XOUT _MSB	XOUT MSB Register	XOUT [15]	XOUT [14]	XOUT [13]	XOUT [12]	XOUT [11]	XOUT [10]	XOUT [9]	XOUT [8]	0x00	R
0x04	YOUT _LSB	YOUT LSB Register	YOUT [7]	YOUT [6]	YOUT [5]	YOUT [4]	YOUT [3]	YOUT [2]	YOUT [1]	YOUT [0]	0x00	R
0x05	YOUT _MSB	YOUT MSB Register	YOUT [15]	YOUT [14]	YOUT [13]	YOUT [12]	YOUT [11]	YOUT [10]	YOUT [9]	YOUT [8]	0x00	R
0x06	ZOUT _LSB	ZOUT LSB Register	ZOUT [7]	ZOUT [6]	ZOUT [5]	ZOUT [4]	ZOUT [3]	ZOUT [2]	ZOUT [1]	ZOUT [0]	0x00	R
0x07	ZOUT _MSB	ZOUT MSB Register	ZOUT [15]	ZOUT [14]	ZOUT [13]	ZOUT [12]	ZOUT [11]	ZOUT [10]	ZOUT [9]	ZOUT [8]	0x00	R

Table 16. XOUT, YOUT, ZOUT Data Output Registers

7.5 (0X08) STATUS REGISTER 1

This register reports the operational mode of the device. Note that the lower 3-bits, the MODE[2:0] field, do not immediately change once a command is written to the MODE register, but may take up to 3 transitions of the heartbeat clock.

			Bit								
Addr	Name	7	6	5	4	3	2	1	0	POR Value	R/W
0x08	STATUS_1	INT_PEND	FIFO_ THRESH	FIFO_FULL	FIFO_ EMPTY	NEW_ DATA	MODE[2]	MODE[1]	MODE[0]	00000000	RO

Bit	Name		Descr	iption
[2:0]	MODE[2:0]	Bit Field	Mode	Comments
		000	SLEEP	Lowest power mode, regulators on, no clock activity, partial chip power-down
		001	STANDBY	Low power mode, no sampling, clocks active.
		010	SNIFF	Sniff activity detection mode, sniff enabled, sniff sampling, no FIFO operations, automatically transition to CWAKE mode upon activity detection
		011	RESV	Reserved
		100	RESV	Reserved
		101	CWAKE	Continuous wake. Active XYZ sampling. Sniff circuitry not active.
		110	SWAKE	Use Sniff logic, main XYZ pipeline and optional FIFO at the same time; highest power consumption

38 / 84

		111	TRIG	Trigger mode, 1 to 254 samples or continuous, return to sleep upon completion				
3	NEW_DATA	 0: No new sample data has arrived since last read. 1: New sample data has arrived and has been written to FIFO/registers. This bit is always enabled and valid, regardless of the settings of any interrupt enable bits. 						
4	FIFO_EMPTY	0: FIFO has one or more samples in storage (level)1: FIFO is empty (level) (default). This bit is set to 1 immediately after device power-up or device reset.						
5	FIFO_FULL	•	e or 1 or more sam 32 samples are us	iples (up to 32) (level). ed (level).				
6	FIFO_THRESH	0: Amount of data in FIFO is less than the threshold (level) 1: Amount of data in FIFO is equal to or greater than the threshold (level)						
7	INT_PEND	=		n register 0x09 (level) pending in register 0x09 (logical				

Table 17. Status Register 1 Settings



7.6 (0X09) STATUS REGISTER 2

This register reports the state of the interrupts ('0' means not pending; '1' means pending). A bit in this register will only be set if the corresponding interrupt enable is set to '1' in (0x17)Interrupt Control Register. Interrupts can be cleared in the following ways using (0x0E)Feature Register 2 bit 4:

Interface

I2C clearing method (default)

I2C clearing method (optional)

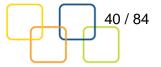
SPI clearing method

<u>Method</u> Read Register 0x09 Write Register 0x09 Write Register 0x09

			Bit								
Addr	Name	7	6	5	4	3	2	1	0	POR Value	R/W
0x09	STATUS_2	INT_ SWAKE	INT_FIFO_ THRESH	INT_FIFO_ FULL	INT_FIFO_ EMPTY	INT_ACQ	INT_WAKE	RESV	RESV	00000000	RO

Bit	Name	Description
[1:0]	Reserved	Reserved.
2	INT_WAKE	This interrupt will transition when the accelerometer automatically moves from SNIFF to CWAKE. Once cleared, another SNIFF to CWAKE event must take place to retrigger it.
3	INT_ACQ	This interrupt will transition when a new sample is acquired. This flag stays high upon the first sample acquired and will not rearm unless cleared. Only active in CWAKE and TRIG modes.
4	INT_FIFO_EMPTY	This interrupt will transition when the FIFO is empty. This flag stays high upon the first empty condition and will not rearm unless cleared. The FIFO empty condition must be negated (e.g. the FIFO must become 'not' empty), and then empty again for the INT_FIFO_EMPTY flag to retrigger.

APS-048-0044v1.5



5	INT_FIFO_FULL	This interrupt will transition when the FIFO is full (32 XYZ samples). This flag stays high upon the first full condition and will not rearm unless cleared. The FIFO full condition must be negated (e.g. the FIFO must become 'not' full), and then full again for the INT_FIFO_FULL flag to retrigger.
6	INT_FIFO_THRESH	This interrupt will transition when the FIFO sample count is equal to or greater than the threshold count 0x16[4:0]. This flag stays high upon the first threshold condition and will not rearm unless cleared.
7	INT_SWAKE	This interrupt will transition when the SNIFF block has detected an event only when the device is in SWAKE mode. Once an SWAKE interrupt is generated, the SNIFF block stops processing new events until the interrupt is cleared and the SNIFF block is reset. Optionally, the SNIFF block can be reset at the same time INT_SWAKE is cleared – see (0x0D) Feature Register 1 bit 4.

Table 18. Status Register 2 Settings



7.7 (0X0D) FEATURE REGISTER 1

This register is used to select the interface mode as well as the operation style of the FIFO and interrupt in SWAKE mode.

NOTE: Software must set only one of the bits SPI_EN or I2C_EN in register 0x0D to '1', depending upon if the I2C or SPI interface will be used for external communications. No data will appear in XOUT, YOUT and ZOUT registers if both the I2C_EN bit and SPI_EN bit are set to 0 (default).

			Bit								
Addr	Name	7	6	5	4	3	2	1	0	POR Value	R/W
0x0D	FREG_1	SPI_EN	I2C_EN	SPI3_EN	INTSC_EN	FREEZE	0	0	0	00000000	RO

Bit	Name	Description
[2:0]	<must '000'="" write=""></must>	Software must always write '000' to these 3 bits
3	FREEZE	This bit is designed to be used with "FIFO stream mode" (register 0x0E bit 5) where the FIFO is configured to continuously capture new samples and flush the oldest after reaching a FIFO full state.
		0: FIFO operates in standard mode, does not stop capturing data in SWAKE interrupt (default).
		1: FIFO stops capturing on SWAKE interrupt, software can examine the conditions which generated the SWAKE event.
4	INTSC_EN	Once an SWAKE interrupt is generated, the SNIFF block stops processing new events until cleared. Enabling this bit allows the SNIFF block to be reset at the same time the INT_SWAKE interrupt is cleared.
		0: Do not re-arm SNIFF block following a SWAKE event (requires the SNIFF block to be reset by exiting SWAKE mode). (default)
		1: Clearing the SWAKE interrupt clears and rearms the SNIFF block for subsequent detections (device may stay in SWAKE mode and continuing processing subsequent SWAKE events once interrupt is cleared).

APS-048-0044v1.5

42 / 84

5	SPI3_EN	0: SPI interface is 4-wire 1: SPI interface is 3-wire (DOUT_A1 is the bidirectional pin)
6	I2C_EN	 0: Device interface is still defined as it was at power-up but no data will appear in XOUT, YOUT and ZOUT registers if both this bit and SPI_EN are set to 0 (default). 1: Disables any SPI communications.
7	SPI_EN	 0: Device interface is still defined as it was at power-up but no data will appear in XOUT, YOUT and ZOUT registers if both this bit and I2C_EN are set to 0 (default). 1: Disables any I2C communications.

Table 19. Feature Register 1 Settings



7.8 (0X0E) FEATURE REGISTER 2

This register allows selection of various features for the FIFO, external trigger input, method of interrupt clearing and burst address wrapping.

			Bit								
Addr	Name	7	6	5	4	3	2	1	0	POR Value	R/W
0x0E	FREG_2	EXT_ TRIG_EN	EXT_ TRIG_POL	FIFO_ STREAM	I2CINT_ WRCLRE	FIFO_ STAT_EN	SPI_ STAT_EN	FIFO_ BURST	WRAPA	00000000	RO

Bit	Name	Description
0	WRAPA	Burst read address wrap control. This bit determines the "roll- back" or wrap address during burst reads. This bit works in I2C mode and both SPI modes.
		0: Burst read cycle address wrap address is 0x07, counter automatically returns to 0x02. (default)
		1: Burst read cycle address wrap address is 0x09, counter automatically returns to 0x02. This setting allows for status registers 0x08 and 0x09 to be included in the burst read.
1	FIFO_BURST	FIFO burst feature. This bit enables address increment logic which allows extended atomic burst reads of the FIFO greater than the standard 6-byte (3x16 bits) atomic burst read of XYZ data. This bit works in I2C mode and both SPI modes.
		0: FIFO burst read cycles are 6-bytes in length, 0x02 to 0x07 per read cycle transaction (default).
		1: FIFO burst read cycle can be any number of 6-byte reads, up to 32 x 6 bytes (i.e. the entire FIFO contents can be read).



2	SPI_STAT_EN	SPI 4-wire mode SPI status token.
		During the first SPI write cycle from the host, enabling this bit will cause the interface to send out system status information on the DOUT_A1 pin without requiring a separate read cycle. See <u>6.11 SPI Status Option</u> .
		0: No SPI status flags are shifted out (default)
		1: SPI status flags are shifted out on the first byte of all 4-wire SPI transactions (SPI 3-wire and I2C modes are not supported, so no effect will be seen in those modes).
3	FIFO_STAT_EN	FIFO status token enable. This bit enables a 4-bit FIFO status token to be appended to the top 4 bits of the Z-channel data in every FIFO read cycle. This feature works in I2C mode and both SPI modes. When enabled, the format of the FIFO status token is:
		0: FIFO status feature is disabled, Z channel FIFO data is not overwritten with FIFO status information. (default)
		1: FIFO status feature is enabled. When the resolution is less than 14-bits, the top 4-bits of 16-bit Z channel FIFO data are replaced with FIFO status information:
		{[INT_PEND, FIFO_TH, FIFO_FULL, FIFO_EMPTY], Z[11:0]}
		When the resolution is 14-bits or above, the bottom 4-bits are replaced:
		{[Z[15:4], INT_PEND, FIFO_TH, FIFO_FULL, FIFO_EMPTY]}
4	I2CINT_WRCLRE	Clear interrupts on register 0x09 write in I2C mode. The default method of interrupt clearing is reading register 0x09, the INT_STATUS or STATUS_2 register. When this bit is enabled, reads to register 0x09 do not clear pending interrupts. SW must write to register 0x09 (contents do not matter) to clear any pending interrupts.
		NOTE: In SPI mode this bit has no effect; SPI interrupt clearing requires a write to register 0x09; reads are not supported.
		0: In I2C mode, interrupts are cleared when reading register 0x09 (default)
		1: if I2C_EN is '1', then interrupts are cleared when writing to register 0x09. Otherwise I2C reads to register 0x09 will still clear pending interrupts.

APS-048-0044v1.5

45 / 84

5	FIFO_STREAM	 FIFO stream or "continuous" write mode. This bit enables the FIFO to be used as a moving sample buffer, discarding the oldest sample data when the FIFO is full and new sample data arrives. This is intended to work primarily with SWAKE mode, but CWAKE mode is also supported. Note that the FIFO_EN bit must be set to '1' for this bit to function. FIFO stream mode works in I2C mode and both SPI modes. 0: FIFO steam mode is disabled, FIFO stops accepting new data when FULL (default) 1: FIFO stream mode is enabled, FIFO discards oldest samples once new data arrives
6	EXT_TRIG_POL	External trigger polarity. 0: Trigger polarity is negative edge triggered (default) 1: Trigger polarity is positive edge triggered
7	EXT_TRIG_EN	 External trigger mode enable. 0: External trigger mode is not enabled (default) 1: External trigger mode is enabled, use INTN pin as the external trigger input. This mode is not used with the TRIG_CMD bit in Register 0x10 bit 7. To use this mode, set the TRIG mode in Register 0x10 bits [2:0].

Table 20. Feature Register 2 Settings



7.9 (0X0F) INITIALIZATION REGISTER 1

Software must write a fixed value to this register immediately after power-up or reset. This register will not typically read-back the value which was written (see below).

			Bit								
Addr	Name	7	6	5	4	3	2	1	0	POR Value	R/W
0x0F	INIT_1	0	1	0	0	0	0	1	0	(See note)	w

Note: During the internal chip start-up sequence, the read-back value will be 0x45. The read-back value will become 0x40 after the start-up sequence completes. After the initialization value of 0x42 is written, the read-back value will be 0x43.

Bit	Name	Description
[7:0]	INIT_1	Software must write a value of 0x42.

Table 21. Initialization Register 1 Settings



7.10 (0X10) MODE CONTROL REGISTER

This register is the primary control register for the accelerometer. The operational mode of the device, X/Y/Z axis enables, and the TRIG one-shot mode can be written through this register. The mode transitions controlled by this register may take up to 3 transitions of the heartbeat clock. Depending on the operation, the lower 3-bits (MCTRL[2:0]) may be automatically set or cleared by hardware if auto-triggered events are executed.

In general, when software sets an operational mode using the MCTRL [2:0] bits, there might be a delay time of 2 to 10 mSec before the operational mode is reflected by the MODE[2:0] bits in Status Register 1.

Å	Addr	Name	Description	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	POR Value	R/W
C	0x10	MODE_C	Mode Control	TRIG_ CMD	Z_AXIS_PD	Y_AXIS_PD	X_AXIS_PD	RESV	MCTRL[2]	MCTRL[1]	MCTRL[0]	0x00	W

Bit	Name		Descr	iption
[2:0]	MCTRL[2:0]	Bit Field	Mode	Comments
		000	SLEEP	Lowest power mode, regulators on, no clock activity, partial chip power-down.
		001	STANDBY	Low power mode, no sampling, clocks active.
		010	SNIFF	Sniff activity detection mode, sniff enabled, no sampling, no FIFO operations, automatically transition to CWAKE mode upon activity detection.
		011	Reserved	Reserved
		100	Reserved	Reserved
		101	CWAKE	Continuous wake. Active XYZ sampling. Sniff circuitry not active.

48 / 84

		110	SWAKE	Use Sniff logic, main XYZ pipeline and optional FIFO at the same time; highest power consumption						
		111	TRIG	Trigger mode, 1 to 254 samples or continuous, return to sleep upon completion.						
3	RESV	Reserved	Reserved							
4	X_AXIS_PD	0: X-axis is enabled. 1: X-axis is disabled.								
5	Y_AXIS_PD	0: Y-axis is enabl 1: Y-axis is disab								
6	Z_AXIS_PD	0: Z-axis is enabl 1: Z-axis is disab								
7	TRIG_CMD	Setting this bit will execute a one-shot trigger mode where 1 to 254 samples are acquired (or the device will continuously sample if the value is 255). The number of samples is specified by the TRIG_COUNT in register 0x29. TRIG mode can only be started from STANDBY. Unless the value is 255, after the number of samples is completed, the device will return to STANDBY mode.								

Table 22. Mode Control Register Settings



7.11 (0X11) RATE REGISTER 1

This register configures the sample rates for wake modes. The rates also depend upon the value in register 0x1C. The device has several power modes which can be adjusted to achieve a desired power consumption at a certain ODR. The tradeoff for lower power is either higher noise or lower ODR. See the table below.

NOTE: The power mode bits referenced in 0x1C are different than for the SNIFF rates.

NOTE: Software must set bits[7:4] to 0.

Addr	Namo	Bit								POR	R/W
Auui	Name	7	6	5	4	3	2	1	0	Value	1.7 11
0x11	RATE_1	0	0	0	0	RR[3]	RR[2]	RR[1]	RR[0]	00000000	RW

Decistor 0:11 Value		ow Power 0]=>0x03)		Power 0]=>0x00)	Precision (0x1C[2:0]=>0x04)		
Register 0x11 Value	CWAKE ODR (Hz)	Current (µA)	CWAKE ODR (Hz)	Current (μA)	CWAKE ODR (Hz)	Current (μA)	
0x05	n/a		14	1	14	5	
0x06	25	0.9	28	1.6	28	10	
0x07	50	1.6	54	2.7	55	18	
0x08	100	2.8	105	5	80	25	
0x09	190	5.5	210	11		n/a	
0x0A	380	10	400	19		n/a	
0x0B	750	18	600	26		n/a	
0x0C	1100	26	n/a		n/a		
0x0F ^{*NOTE}	1300	36	750	36	100	36	

Table 23. Rate Register 1 Settings

NOTE: Specific setup steps are required in order to set up Register 0x11 value 0x0F ("Rate 15"), as shown below. These steps are not required when using the other modes:



MC3635 3-Axis Accelerometer

	Write Desister	Valu	es To Be Wr	itten	
Step	Write Register Address	ULP	LP	Precision	Comment
1	0x10		0x01		Go to standby
2	0x15	((0x04 or othe	r)	<desired &="" range="" resolution=""></desired>
3	0x16	(0x5D or other)			<desired fifo="" settings=""></desired>
4	0x1C	0x03	0x00	0x04	Choose mode
5	0x11		0x10		Point to set wake/sniff settings
6	0x29		0x03		Rate 15 setup 1 for CWAKE
7	0x11		0x20		Rate 15 setup 2 for CWAKE
8	0x29		0x01		Rate 15 setup 3 for CWAKE
9	0x11		0x40		Point to value 1
10	0x29	0x52	0x72	0x32	Write value 1
11	0x11		0x50		Point to value 2
12	0x29	0x01	0x02	0x12	Write value 2
13	0x11		0x0F		Apply the values
14	0x10		0x05		Go to CWAKE

Table 24. Setup Steps for CWAKE Using "Rate 15"



7.12 (0X12) SNIFF CONTROL REGISTER

This register selects the sample rate for SNIFF mode and the clock rate for STANDBY mode.

NOTE: The power mode bits referenced in 0x1C are different than for the WAKE rates. NOTE: Software must always write 0 to bit 4.

Addr	Name	Bit									R/W
Addr		7	6	5	4	3	2	1	0	Value	
0x12	SNIFF_C	STB_RATE[2]	STB_RATE[1]	STB_RATE[0]	0	SNIFF_SR [3]	SNIFF_SR [2]	SNIFF_SR [1]	SNIFF_SR [0]	00000000	RW

Bit	Name		Descript	tion							
[3:0]	SNIFF_SR[3:0]		Approximate typical maximum clock rate when trigger count > 1 (Hz)								
		Bit Field	Ultra-Low Power (0x1C[6:4]=>0x03)	Low Power (0x1C[6:4]=>0x00)	Precision (0x1C[6:4]=>0x04)						
		0000 (default)	6	7	7						
		0001	0.4	0.4	0.2						
		0010	0.8	0.8	0.4						
		0011	1.5	1.5	0.9						
		0100	6	7	7						
		0101	13	14	14						
		0110	25	28	28						
		0111	50	54	55						
		1000	100	105	80						
		1001	190	210	n/a						
		1010	380	400	n/a						

52 / 84

MC3635 3-Axis Accelerometer

		1011	750	600	n/a
		1100	1100	n/a	n/a
		1101	n/a	n/a	n/a
		1110	n/a	n/a	n/a
		1111 ^{*NOTE}	1300	750	100
4	0	Software mus	t always write 0 to this b	it.	
[7:5]	STB_RATE[2:0]		Approximate typical m	aximum clock rate	9
			when trigger co	unt > 1 (Hz)	
		Bit Field	Ultra-Low Power (0x1C[6:4]=>0x03)	Low Power (0x1C[6:4]=>0x00)	Precision (0x1C[6:4]=>0x04)
		000 (default)	1	0.5	0.1
		001	3	1	0.2
		010	5	3	0.4
		011	10	6	0.8
		100	23	12	1.5
		101	45	24	3
		110	90	48	5
		111	180	100	10

 Table 25. Sniff Control Register Settings

NOTE: Specific setup steps are required in order to set up Register 0x12 value 0x0F ("Rate 15") for sniff, as shown below. These steps are not required when using the other modes:



MC3635 3-Axis Accelerometer

	Write	Valu	es To Be Wri	itten	
Step	Register Address	ULP	LP Precision		Comment
1	0x10		0x01		Go to standby
2	0x15	((0x04 or othe	r)	<desired &="" range="" resolution=""></desired>
3	0x16	((0x5D or othe	r)	<desired fifo="" settings=""></desired>
4	0x1C	0x30	0x00	0x40	Choose mode
5	0x11		0x10		Point to set wake/sniff settings
6	0x29		0x30		Rate 15 setup 1 for sniff
7	0x11		0x30		Rate 15 setup 2 for sniff
8	0x29		0x01		Rate 15 setup 3 for sniff
9	0x11		0x60		Point to value 1
10	0x29	0x52	0x72	0x32	Write value 1
11	0x11		0x70		Point to value 2
12	0x29	0x01	0x02	0x12	Write value 2
13	0x11		0x0F		Apply the values
14	0x10		0x02		Go to sniff

Table 26. Setup Steps For Sniff Using "Rate 15"



7.13 (0X13) SNIFF THRESHOLD CONTROL REGISTER

This register sets the threshold values used by the SNIFF logic for activity detection. For each axis, a delta count is generated and compared to the threshold. When the delta count is greater than the threshold, a SNIFF wakeup event occurs. There is a unique sniff threshold for each axis, and an optional "false detection count" which requires multiple sniff detection events to occur before a wakeup condition is declared. These features are set by six shadow registers accessed by register 0x13[5:0] and register 0x14 bits [2:0].

The SNIFF block supports the logical AND or OR of the X/Y/Z SNIFF wakeup flags when generating a SNIFF wakeup interrupt.

The SNIFF block supports two methods of calculating SNIFF delta counts:

- Current Sample to Previous Sample (C2P)
 - The current sample and the immediate previous sample are subtracted to generate a delta
- Current Sample to Baseline (C2B)
 - The current sample and the first sample captured when entering SNIFF mode are subtracted to generate a delta.

			Bit								
Addr	Name	7	6	5	4	3	2	1	0	POR Value	R/W
0x13	SNIFFTH_C	SNIFF_ MODE	SNIFF_ AND_OR	SNIFF_TH[5]	SNIFF_TH[4]	SNIFF_TH[3]	SNIFF_TH[2]	SNIFF_TH[1]	SNIFF_TH[0]	00000000	RW

Bit	Name		Description		
[5:0]	SNIFF_TH[5:0]	This 6-bit field accesses six shadow registers behind address 0x: Register 0x14 bits [2:0] control which register is accessed.			
		Reg 0x14			
		SNIFF_T_ADDR[2:0]	SNIFF_TH[5:0]		
		000	None		
		001	SNIFF Threshold, X-axis		
			SNIFF_TH_X[5:0], unsigned threshold value 0 to 63 (independent from Y and Z thresholds).		

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MC3635 3-Axis Accelerometer

010	SNIFF Threshold, Y-axis SNIFF_TH_Y[5:0], unsigned threshold value 0 to 63 (independent from X and Z thresholds).
011	SNIFF Threshold, Z-axis SNIFF_TH_Z[5:0], unsigned threshold value 0 to 63 (independent from X and Y thresholds).
100	None
101	SNIFF Detection Count, X-axis SNIFF_X_COUNT[5:0], unsigned SNIFF event count, 1 to 62 events, independent from other channels. The detection count is COUNT-1 for the desired number of events (for 1 event = 1-1 => 0 loaded into register).
110	SNIFF Detection Count, Y-axis SNIFF_Y_COUNT[5:0], unsigned SNIFF event count, 1 to 62 events, independent from other channels. The detection count is COUNT-1 for the desired number of events (for 1 event = 1-1 => 0 loaded into register).
111	SNIFF Detection Count, Z-axis SNIFF_Z_COUNT[5:0], unsigned SNIFF event count, 1 to 62 events, independent from other channels. The detection count is COUNT-1 for the desired number of events (for 1 event = 1-1 => 0 loaded into register).



6	SNIFF_AND_OR	 Sets the logical mode for combining of X/Y/Z SNIFF wakeup events before an interrupt is generated. To remove one of the channels (axis) from the equation, use the corresponding axis PD bit in register 0x10 bits [6:4]. O: OR - SNIFF wakeup/interrupt is triggered when any of the active channels have met detection threshold and count requirements (default). 			
		Sniff Wakeup =	$\Delta(abs(X) - X Sniff Threshold) or \Delta(abs(Y) - Y Sniff Threshold) or \Delta(abs(Z) - Z Sniff Threshold)$		
			errupt is triggered when all active on threshold and count requirements. Δ(abs(X) – X Sniff Threshold) and Δ(abs(Y) – Y Sniff Threshold) and Δ(abs(Z) – Z Sniff Threshold)		
7	SNIFF_MODE	0: C2P Mode (Current to Pr current and previous samp logic uses the current samp to compute a delta (default 1: C2B Mode (Current to Ba	aseline): The delta count is generated nt sample from the first sample stored		

Table 27. Sniff Threshold Control Register Settings



7.14 (0X14) SNIFF CONFIGURATION REGISTER

This register selects which of the six shadow registers is being accessed in register 0x13, and controls settings of the SNIFF hardware.

			Bit								
Addr	Name	7	6	5	4	3	2	1	0	POR Value	R/W
0x14	SNIFFCF_C	SNIFF_ RESET	SNIFF_ MUX[2]	SNIFF_ MUX[1]	SNIFF_ MUX[0]	SNIFF_ CNTEN	SNIFF_ THADR[2]	SNIFF_ THADR[1]	SNIFF_ THADR[0]	00000 000	RW

Bit	Name		Description
[2:0]	SNIFF_THADR[2:0]	Bit Field	Register selected by 0x13[5:0]
		000	None
		001	SNIFF Threshold, X-axis
		010	SNIFF Threshold, Y-axis
		011	SNIFF Threshold, Z-axis
		100	None
		101	SNIFF Detection Count, X-axis
		110	SNIFF Detection Count, Y-axis
		111	SNIFF Detection Count, Z-axis
3	SNIFF_ CNTEN	This bit enables the S	NIFF detection counts for all channels.
		0: Do not use SNIFF d	etection counters. (default)
		1: Enable SNIFF detec wakeup	ction counts, required for valid SNIFF
[6:4]	SNIFF_ MUX[2:0]	will be compared aga channel. Clamp logic	which 6-bits of the 11-bit delta count inst the 6-bit threshold value for each allows any SNIFF delta exceeding the to still be detected as a valid event. See

APS-048-0044v1.5

58 / 84

		Bit Field	Bit range selected
		000	DELTA[5:0]
		001	DELTA[6:1]
		010	DELTA[7:2]
		011	DELTA[8:3]
		100	DELTA[9:4]
		101	DELTA[10:5]
		110	DELTA[10:5]
		111	DELTA[10:5]
7	SNIFF_ RESET	This is the manual reset bit for self-clearing, and can be used to after a SNIFF event has been de 0: SNIFF block reset is not appli 1: SNIFF block reset is applied.	o re-enable the SNIFF block etected in SWAKE mode.

Table 28. Sniff Configuration Register Settings

Some example settings for the SNIFF_MUX field are shown below:

Sniff Noise/Power Configuration	Δg	Threshold [5:0]	Sniff Mux Sel [2:0]	Example Use Case
	Low	3		Human motion detection @ SR = 6.5 Hz and Sniff Mode = "Current to Baseline"
Ultra-Low Power	Med	10	0	
	High	28	0	Tap detection @ SR = 51 Hz and Sniff Mode = "Current to Previous"
	Low	5	0	
Low Power	Med	5	0	
	High	56	0	
	X Low	3	0	
Drasisian	Low	37	0	
Precision	Med	37	2	
	High	56	3	



7.15 (0X15) RANGE AND RESOLUTION CONTROL REGISTER

The RANGE register sets the resolution and range options for the accelerometer. All numbers are sign-extended, 2's complement format. All results are reported in registers 0x02 to 0x07.

When the FIFO is enabled, only 6 to 12-bit resolutions are supported due to the 12-bit width of the FIFO.

			Bit								
Addr	Name	7	6	5	4	3	2	1	0	POR Value	R/W
0x15	RANGE_C	RESV	RANGE[2]	RANGE[1]	RANGE[0]	RESV	RES[2]	RES[1]	RES[0]	00000000	RW

Bit	Name		Description
[2:0]	RES[2:0]	Bit Field	Bit Width of Accelerometer Data
		000	6 bits
		001	7 bits
		010	8 bits
		011	10 bits
		100	12 bits
		101	14 bits (only 12-bits if FIFO enabled)
		110	Reserved
		111	Reserved
3	RESV	Reserved	
[6:4]	RANGE[2:0]	Bit Field	G Range Selection
		000	±2g
		001	±4g
		010	±8g

60 / 84

		011	±16g
		100	±12g
		101	Reserved
		110	Reserved
		111	Reserved
7	RESV	Reserved	

 Table 29. Range and Resolution Control Register Settings



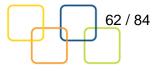
7.16 (0X16) FIFO CONTROL REGISTER

This register selects the FIFO threshold level, operation mode, FIFO reset and enable. With the exception of FIFO_RESET, the FIFO_EN bit must be '1' for any FIFO interrupts, thresholds, or modes to be enabled. The FIFO flags in register 0x08 will continue to report FIFO defaults even if the FIFO_EN is '0'.

			Bit								
Addr	Name	7	6	5	4	3	2	1	0	POR Value	R/W
0x16	FIFO_C	FIFO_ RESET	FIFO_EN	FIFO_ MODE	FIFO_TH [4]	FIFO_TH [3]	FIFO_TH [2]	FIFO_TH [1]	FIFO_TH [0]	0000000	RW

Bit	Name	Description
[4:0]	FIFO_TH[4:0]	The FIFO threshold level selects the number of samples in the FIFO for different FIFO events. The threshold value may be 1 to 31 (00001 to 11111).
5	FIFO_MODE	 0: Normal operation, the FIFO continues to accept new sample data as long as there is space remaining (default) 1: Watermark, once the amount of samples in the FIFO reaches or exceeds the threshold level, the FIFO stops accepting new sample data. Any additional sample data is "dropped".
6	FIFO_EN	 FIFO enable control. All FIFO operations are gated by this bit. 0: No FIFO operation, sample data written directly to output registers. 1: FIFO enabled, all sample data written to FIFO write port if there is room. The FIFO write clock is controlled by this enable, resulting in higher dynamic power.
7	FIFO_RESET	Asynchronous FIFO reset. 0: FIFO reset is disabled, normal operation (default) 1: FIFO read and write pointers are cleared, FIFO contents returned to 0

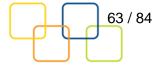
Table 30. FIFO Control Register Settings



7.17 (0X17) INTERRUPT CONTROL REGISTER

					Bit						
Addr	Name	7	6	5	4	3	2	1	0	POR Value	R/W
0x17	INTR_C	INT_ SWAKE	INT_FIFO_ THRESH	INT_FIFO_ FULL	INT_FIFO_ EMPTY	INT_ACQ	INT_ WAKE	IAH	IPP	0000000	RW

Bit	Name	Description
0	IPP	 INTN pin interrupt pin mode control. 0: INTN pin is configured for open-drain mode (external pullup to VDDIO required) (default). 1: INTN pin is configured for active drive or "push-pull" mode. Drive level is to VDDIO.
1	ІАН	Interrupt level control, sets the active drive level of the INTN pin. 0: Interrupt request is active low (default). 1: Interrupt request is active high.
2	INT_WAKE	 WAKE interrupt (SNIFF to WAKE) enable 0: No interrupt is generated when SNIFF activity is detected and the device auto-transitions to CWAKE mode (default). 1: Generate an interrupt when activity is detected in SNIFF mode and the device auto-transitions to CWAKE mode.
3	INT_ACQ	Interrupt on sample or acquisition enable 0: No interrupt generated when new sample data is acquired (default). 1: Generate an interrupt when new sample data is acquired (applies to new data written to output registers or FIFO). This enable is paired with the NEW_DATA flag in register 0x08.
4	INT_FIFO_EMPTY	 FIFO empty interrupt enable. 0: No interrupt is generated when the FIFO is empty or completely drained of sample data (default). 1: Generate an interrupt when the FIFO is empty. This interrupt is paired with the FIFO_EMPTY flag in register 0x08. Note that this interrupt is independent of the FIFO threshold level, and will only activate when the FIFO sample count has reached a value of 0.



5	INT_FIFO_FULL	 FIFO full interrupt enable. 0: No interrupt is generated when the FIFO is empty or completely filled of sample data (default). 1: Generate an interrupt when the FIFO is full. This interrupt is paired with the FIFO_FULL flag in register 0x08. Note that this interrupt is independent of the FIFO threshold level, and will only activate when the FIFO sample count has reached a value of 32.
6	INT_FIFO_THRESH	FIFO threshold interrupt enable.0: No interrupt is generated when the FIFO threshold level is reached (default).1: Generate an interrupt when the FIFO threshold level is reached.
7	INT_SWAKE	This interrupt is valid only in SWAKE mode.0: No interrupt generated when SNIFF activity is detected (default).1: Generate an interrupt when SNIFF activity is detected.





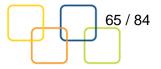
7.18 (0X1A) INITIALIZATION REGISTER 3

Software must write a fixed value to this register immediately after power-up or reset.

					В	iit					
Addr	Name	7	6	5	4	3	2	1	0	POR Value	R/W
0x1A	INIT_3	0	0	0	0	0	0	0	0	00000000	RW

Bit	Name	Description
[7:0]	INIT_3	Software must write '0' to these bits

Table 32. Initialization Register 3 Settings



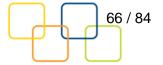
7.19 (0X1B) SCRATCHPAD REGISTER

This register can store any 8-bit value and has no effect on hardware.

					В	it					
Addr	Name	7	6	5	4	3	2	1	0	POR Value	R/W
0x1B	SCRATCH	0	0	0	0	0	0	0	0	00000000	RW

Bit	Name	Description
[7:0]	SCRATCH	Any value can be written and read-back.

Table 33. Scratchpad Register



7.20 (0X1C) POWER MODE CONTROL REGISTER

This register selects the power setting for CWAKE, SWAKE and SNIFF modes.

			Bit				
Addr	Name	7	6	54321	0	POR Value	R/W
0x1C	PMCR	SPI_HS_E N	SPM[2]	S S R C C P P E S S N N S P P [[V N N 1 O [[]] 2 1]]	CSPM[0]	0000000	RW

Bit	Name	Description
[2:0]	CSPM	CWAKE, SWAKE Power Mode
		000: Low Power Mode (nominal noise levels) (default)
		001: Reserved
		010: Reserved
		011: Ultra-Low Power Mode (highest noise levels)
		100: Precision Mode (lowest noise levels)
		101: Reserved
		110: Reserved
		111: Reserved
3	RESV	Reserved
[6:4]	SPM	SNIFF Power Mode
		000: Low Power Mode (nominal noise levels) (default)
		001: Reserved
		010: Reserved
		011: Ultra-Low Power Mode (highest noise levels)
		100: Precision Mode (lowest noise levels)
		101: Reserved
		110: Reserved
		111: Reserved

APS-048-0044v1.5

67 / 84

7	SPI_HS_EN	SPI High-Speed Enable
		0: This bit will always return a '0' when read. Software must keep track of the state of this bit.
		Follow sequence from <u>6.12 SPI High-Speed Mode</u> to enable high-speed SPI mode.

Table 34. Power Mode Control Register Settings



7.21 (0X20) DRIVE MOTION X REGISTER

This register controls the test mode which moves the sensor in the X axis direction and initializes specific hardware bits.

NOTE: Software must always write 0 to bits [7:4] and 1.

NOTE: Software must always write 1 to bit 0.

			Bit								
Addr	Name	7	6	5	4	3	2	1	0	POR Value	R/W
0x20	DMX	0	0	0	0	DNX	DPX	0	1	00000000	w

Bit	Name	Description
0	1	Reserved. Always write 1 to this bit
1	0	Reserved. Always write 0 to this bit.
2	DPX	0: Disabled (default) 1: Move the sensor in X Positive direction
3	DNX	0: Disabled (default) 1: Move the sensor in X Negative direction
[7:4]	0000	Reserved. Always write 0 to these bits.

Table 35. Drive Motion X Register Settings



7.22 (0X21) DRIVE MOTION Y REGISTER

This register controls the test mode which moves the sensor in the Y axis direction and initializes specific hardware bits.

NOTE: Software must always write 0 to bits [6:4] and [1:0].

NOTE: Software must always write 1 to bit 7 after writing to register 0x20[0].

			Bit								
Addr	Name	7	6	5	4	3	2	1	0	POR Value	R/W
0x21	DMY	1	0	0	0	DNY	DPY	0	0	(See table)	RW

Mode (MCTLR[2:0] bits in MODE_C Register 0x10)	Read-back Value
SNIFF, CWAKE, SWAKE, TRIG	0x80
SLEEP, STANDBY	0x00

Table 36. Register 0x21 Read-Back Value

Bit	Name	Description
[1:0]	00	Reserved. Always write 0 to these bits.
2	DPY	0: Disabled (default) 1: Move the sensor in Y Positive direction
3	DNY	0: Disabled (default) 1: Move the sensor in Y Negative direction
[6:4]	000	Reserved. Always write 0 to these bits.
7	1	Reserved. Always write 1 to this bit.

Table 37. Drive Motion Y Register Settings



7.23 (0X22) DRIVE MOTION Z REGISTER

This register controls the test mode which moves the sensor in the Z axis direction.

NOTE: Software must always write 0 to bits [7:4] and [1:0].

			Bit								
Addr	Name	7	6	5	4	3	2	1	0	POR Value	R/W
0x22	DMZ	0	0	0	0	DNZ	DPZ	0	0	00000000	RW

Bit	Name	Description
[1:0]	00	Reserved. Always write 0 to these bits.
2	DPZ	0: Disabled (default) 1: Move the sensor in Z Positive direction
3	DNZ	0: Disabled (default) 1: Move the sensor in Z Negative direction
[7:4]	0000	Reserved. Always write 0 to these bits.

Table 38. Drive Motion Z Register Settings



7.24 (0X24) RESET REGISTER

This register can be used to reset the device. Anytime there is a reset to the device, a POR event, or a power cycle the SPI 3-wire configuration will reset to 4-wire mode.

			Bit								
Addr	Name	7	6	5	4	3	2	1	0	POR Value	R/W
0x24	RESET	RELOAD	RESET	RESV	RESV	RESV	RESV	RESV	RESV	00000000	RW

Bit	Name	Description
[5:0]	Reserved	Reserved
6	RESET	 0: Normal operation (default) 1: Force a power-on-reset (POR) sequence. OTP contents are reloaded into registers, AOFS contents are decompressed, and any other registers are returned to their default. This bit is self-clearing.
7	RELOAD	 0: Normal operation (default) 1: Reloads the registers from OTP. A RELOAD operation enables OTP core for reading, performs a complete read of OTP into the register file, and then disables the OTP. Use register 0x01 bit 5 to monitor the OTP_BUSY bit. This bit must be cleared by software

Table 39. Reset Register Settings



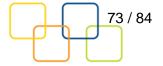
7.25 (0X28) INITIALIZATION REGISTER 2

Software must write a fixed value to this register immediately after power-up or reset.

			Bit									
Addr	Name	7	6	5	4	3	2	1	0	POR Value	R/W	
0x28	INIT_2	0	0	0	0	0	0	0	0	00000000	RW	

Bit	Name	Description
[7:0]	INIT_2	Software must write '0' to these bits

 Table 40. Initialization Register 2 Settings



7.26 (0X29) TRIGGER COUNT REGISTER

This register selects the number of samples to be taken after the one-shot trigger is started.

			Bit									
Addr	Name	7	6	5	4	3	2	1	0	POR Value	R/W	
0x29	TRIGC	TRIGC[7]	TRIGC[6]	TRIGC[5]	TRIGC[4]	TRIGC[3]	TRIGC[2]	TRIGC[1]	TRIGC[0]	00000000	RW	

Bit	Name	Description
[7:0]	TRIGC[7:0]	Selects the number of samples to be captured after the one- shot trigger is started. Range from 1 to 254. When value 255 is chosen, the device will run continuously until the mode in register 0x10 is changed.

Table 41. Trigger Register Settings



7.27 (0X2A – 0X2B) X-AXIS OFFSET REGISTERS

This register contains a signed 2's complement 15-bit value applied as an offset adjustment to the output of the acceleration values, prior to being sent to the OUT_EX registers. The Power-On-Reset value for each chip is unique and is set as part of factory calibration. If necessary, this value can be overwritten by software.

NOTE: When modifying these registers with new gain or offset values, software should perform a read-modify-write type of access to ensure that unrelated bits do not get changed inadvertently.

Addr	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	POR Value	R/W
0x2A	XOFFL	XOFF[7]	XOFF[6]	XOFF[5]	XOFF[4]	XOFF[3]	XOFF[2]	XOFF[1]	XOFF[0]	Per chip	W
0x2B	XOFFH	XGAIN[8]	XOFF[14]	XOFF[13]	XOFF[12]	XOFF[11]	XOFF[10]	XOFF[9]	XOFF[8]	Per chip	W

Table 42. X-Axis Offset Registers



7.28 (0X2C – 0X2D) Y-AXIS OFFSET REGISTERS

This register contains a signed 2's complement 15-bit value applied as an offset adjustment to the output of the acceleration values, prior to being sent to the OUT_EX registers. The Power-On-Reset value for each chip is unique and is set as part of factory calibration. If necessary, this value can be overwritten by software.

NOTE: When modifying these registers with new gain or offset values, software should perform a read-modify-write type of access to ensure that unrelated bits do not get changed inadvertently.

Addr	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	POR Value	R/W
0x2C	YOFFL	YOFF[7]	YOFF[6]	YOFF[5]	YOFF[4]	YOFF[3]	YOFF[2]	YOFF[1]	YOFF[0]	Per chip	W
0x2D	YOFFH	YGAIN[8]	YOFF[14]	YOFF[13]	YOFF[12]	YOFF[11]	YOFF[10]	YOFF[9]	YOFF[8]	Per chip	W

Table 43. Y-Axis Offset Registers



7.29 (0X2E – 0X2F) Z-AXIS OFFSET REGISTERS

This register contains a signed 2's complement 15-bit value applied as an offset adjustment to the output of the acceleration values, prior to being sent to the OUT_EX registers. The Power-On-Reset value for each chip is unique and is set as part of factory calibration. If necessary, this value can be overwritten by software.

NOTE: When modifying these registers with new gain or offset values, software should perform a read-modify-write type of access to ensure that unrelated bits do not get changed inadvertently.

Addr	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	POR Value	R/W
0x2E	ZOFFL	ZOFF[7]	ZOFF[6]	ZOFF[5]	ZOFF[4]	ZOFF[3]	ZOFF[2]	ZOFF[1]	ZOFF[0]	Per chip	W
0x2F	ZOFFH	ZGAIN[8]	ZOFF[14]	ZOFF[13]	ZOFF[12]	ZOFF[11]	ZOFF[10]	ZOFF[9]	ZOFF[8]	Per chip	W

Table 44. Z-Axis Offset Registers



7.30 (0X2B & 0X30) X-AXIS GAIN REGISTERS

The gain value is an unsigned 9-bit number.

NOTE: When modifying these registers with new gain or offset values, software should perform a read-modify-write type of access to ensure that unrelated bits do not get changed inadvertently.

Addr	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	POR Value	R/W
0x2B	XOFFH	XGAIN[8]	XOFF[14]	XOFF[13]	XOFF[12]	XOFF[11]	XOFF[10]	XOFF[9]	XOFF[8]	Per chip	W
0x30	XGAIN	XGAIN[7]	XGAIN[6]	XGAIN[5]	XGAIN[4]	XGAIN[3]	XGAIN[2]	XGAIN[1]	XGAIN[0]	Per chip	W

Table 45. X-Axis Gain Registers



7.31 (0X2D & 0X31) Y-AXIS GAIN REGISTERS

The gain value is an unsigned 9-bit number.

NOTE: When modifying these registers with new gain or offset values, software should perform a read-modify-write type of access to ensure that unrelated bits do not get changed inadvertently.

Addr	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	POR Value	R/W
0x2D	YOFFH	YGAIN[8]	YOFF[14]	YOFF[13]	YOFF[12]	YOFF[11]	YOFF[10]	YOFF[9]	YOFF[8]	Per chip	W
0x31	YGAIN	YGAIN[7]	YGAIN[6]	YGAIN[5]	YGAIN[4]	YGAIN[3]	YGAIN[2]	YGAIN[1]	YGAIN[0]	Per chip	W

Table 46. Y-Axis Gain Registers



7.32 (0X2F & 0X32) Z-AXIS GAIN REGISTERS

The gain value is an unsigned 9-bit number.

NOTE: When modifying these registers with new gain or offset values, software should perform a read-modify-write type of access to ensure that unrelated bits do not get changed inadvertently.

Addr	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	POR Value	R/W
0x2F	ZOFFH	ZGAIN[8]	ZOFF[14]	ZOFF[13]	ZOFF[12]	ZOFF[11]	ZOFF[10]	ZOFF[9]	ZOFF[8]	Per chip	W
0x32	ZGAIN	ZGAIN[7]	ZGAIN[6]	ZGAIN[5]	ZGAIN[4]	ZGAIN[3]	ZGAIN[2]	ZGAIN[1]	ZGAIN[0]	Per chip	W

Table 47. Z-Axis Gain Registers



8 INDEX OF TABLES

Table 1. Order Information	5
Table 2. Top Marking Specification	5
Table 3. Pin Description	9
Table 4. Absolute Maximum Ratings	16
Table 5. Sensor Characteristics	17
Table 6. Electrical Characteristics – Voltage and Current	18
Table 7. Electrical Characteristics – Interface	19
Table 8. I2C Timing Characteristics	20
Table 9. SPI Interface Timing Parameters	21
Table 10. Recommended Initialization Sequence	22
Table 11. Operational Modes	24
Table 12. I2C Address Selection	
Table 13. Register Summary	34
Table 14. Extended Status Register 1 Settings	35
Table 15. Extended Status Register 2 Settings	36
Table 16. XOUT, YOUT, ZOUT Data Output Registers	37
Table 17. Status Register 1 Settings	39
Table 18. Status Register 2 Settings	41
Table 19. Feature Register 1 Settings	43
Table 20. Feature Register 2 Settings	46
Table 21. Initialization Register 1 Settings	47
Table 22. Mode Control Register Settings	49
Table 23. Rate Register 1 Settings	50
Table 24. Setup Steps for CWAKE Using "Rate 15"	51
Table 25. Sniff Control Register Settings	53
Table 26. Setup Steps For Sniff Using "Rate 15"	54
Table 27. Sniff Threshold Control Register Settings	57
Table 28. Sniff Configuration Register Settings	59
Table 29. Range and Resolution Control Register Settings	61
Table 30. FIFO Control Register Settings	62
Table 31. Interrupt Control Register Settings	64
Table 32. Initialization Register 3 Settings	65

APS-048-0044v1.5



Table 33. Scratchpad Register	66
Table 34. Power Mode Control Register Settings	68
Table 35. Drive Motion X Register Settings	69
Table 36. Register 0x21 Read-Back Value	70
Table 37. Drive Motion Y Register Settings	70
Table 38. Drive Motion Z Register Settings	71
Table 39. Reset Register Settings	72
Table 40. Initialization Register 2 Settings	73
Table 41. Trigger Register Settings	74
Table 42. X-Axis Offset Registers	75
Table 43. Y-Axis Offset Registers	76
Table 44. Z-Axis Offset Registers	77
Table 45. X-Axis Gain Registers	78
Table 46. Y-Axis Gain Registers	79
Table 47. Z-Axis Gain Registers	80



9 REVISION HISTORY

Date	Revision	Description
2015-10	APS-048-0044v1.0	First release.
2015-12	APS-048-0044v1.1	Added register details.
2015-12	APS-048-0044v1.2	Updated SPI clock speed parameters. Corrected pinouts in table. Added scratchpad register. Corrected some typos.
2016-02	APS-048-0044v1.3	Updated 5.3 initialization sequence. Updated Rate 15 sequences for CWAKE and SNIFF.
2017-03	APS-048-0044v1.4	Updated SPI clock speed and added description of sequence.
2017-09	APS-048-0044v1.5	Added soldering profile, shipping and handling guidelines, moisture sensitivity level control Eived a two by changing "Sensitivity Temperature Coefficient" from 0.15 to
		 Fixed a typo by changing "Sensitivity Temperature Coefficient" from 0.15 to 0.015 %/°C
		Updated Zero-g Offset condition



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APS-048-0044v1.5

84 / 84



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